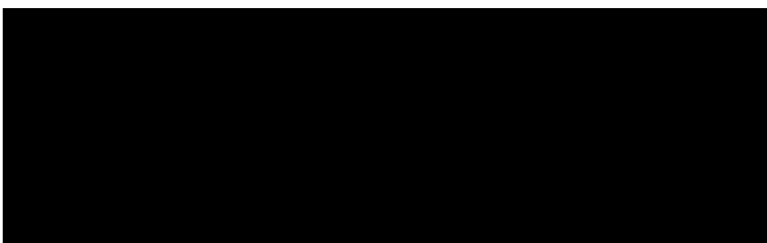


STATINTL

Approved For Release 2001/11/19 : CIA-RDP78B04747A000300030004-2



5 May 1965

Please Reference:
4W-1390.4

FW
U. S. Government
Washington, D. C.

STATINTL Subject: Contract [REDACTED] - Film Chip Processor

Gentlemen:

To improve the quality of film developed by the film chip processor supplied under subject contract, the [REDACTED] requests a contract modification to provide for quick immersion of film chips into developer solution. This new immersion method will result in development control not previously obtainable.

STATINTL

In addition to this modification, your technical representative has requested a modification to the load section of the processor to increase film chip capacity from 24 to 36. As a result of the weight of the additional chips, the automatic feed section requires redesign. To accomplish both of these modifications an extension of delivery to 15 June 1965 and additional funds of [REDACTED] are re-

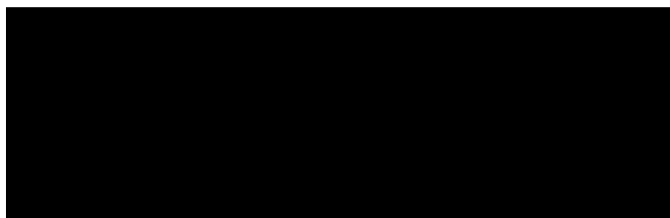
STATINTL

STATINTL We thank you for the consideration of our proposal and should additional information be desired please feel free to contact [REDACTED] in Washington.

STATINTL

STATINTL

Very truly yours,



FCM:gw

President

Declass Review by NIMA/DOD